ABBOCIATION CONNECTING ELECTRONICS (NOUSTRIES IN CONNECTING ELECTRONICS (NOUSTRIES IN CONNECTING) International and Pan-American co	burn. Illinois. All rights reserved u	Inder both This doc level par	ument is a declarati ts, the declaration e	on of the substance ncompasses all low	es within the manufactur wer level materials for wl	er listed item. Note: i hich the manufacture	f the item is an as r has engineering	ssembly with lower responsibility.		
IPC Web Site for Information on I   http://www.ipc.org/IPC-175x	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute			Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information						
Supplier Information										
Company name*	any name* Company unique ID		Unique ID Authority			Response Date*				
onsemi						2025-08-01				
Contact Name	Title - Contact		Phone - Contac	Phone - Contact*			Email - Contact*			
Product-Env-Stewards	Product Enviro Compliance		NA			Product-Env-Stewards@onsemi.com				
uthorized Representative* Title - Representative			Phone - Representative*			Email - Representative*				
Product-Env-Stewards	Product Enviro Compliance	/iro Compliance		NA			Product-Env-Stewards@onsemi.com			
Requester Item Number Mfr Iten	Number Mfr Item Name		Effective Date	Version	Manufacturing Site	Weight*	UOM	Unit Type		
NRVTS	360ETFSTAG 3A 60V Trench S	chottky u8FL	2025-08-01		MY1	32.25	mg	Each		
Manufacturing Proccess Information							· · ·			
Terminal Plating / Grid Array Material	Terminal Base Alloy J-STD-020 MS		Peak Proc	Peak Process Body Temperature Max Time at Pea		k Temperature Number of Reflow Cycles				
Matte Tin (Sn) - annealed CU Alloy 1		1	260	C	30	seconds 3				
Comments										
level 1 - maximum time at peak temperature during so	ldering is 10-30 seconds									
For more information regarding material composition	please refer to page 3									

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chro	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).								
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company	ated biphenyls and/or polybrominated dip s of an applicable quantity limit, please in iffies that it gathered the information it pr m.Supplier acknowledges that Company ave relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substa ndicate below which, if any, RoHS exemption ovides in this form using appropriate methoo will rely on this certification in determining ers in completing this form, and that Supplie num, itssuppliers have provided certification eement with respect to the identified part, the Company's remedies for issues that arise reg	nce") in exco n you believe ls to ensure i the compliar r may not ha s regarding t terms and co	e may apply. If the part is an assembly with low s accuracy and that such information is true an ce of its products with European Union member de independently verified such information. Ho neir contributions to the part, and those certifica	ove. If a homogeneous material within the part er level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 4 - Item(	s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted					
Exemption: 7a: Lead in high melting temp	erature type solders (i.e. lead based sol	der alloys containing 85% by weight or m	ore lead).							
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the					
Supplier Digital Signature	astislav Drska	Le								

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select	the Level (JIG A, JIG B)	. Requester or Supplier) [B	l select the substa	ance category (JIG or Requester) or enter	a value (Supplier). [C] selec	t the substance (J	[G] or enter the substa	nce and CAS (Other). [D]
select a RoHS exemption, if applied sigma range of distribution unless	cable [E] enter the weigh	t of the substance or the Pl	PM concentration	[F] Optionally enter the positive (+) and	negative (-) tolerance in per	cent (Note: percer	nt tolerance values are	expected to cover a 3
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Evenut	Weight	Unit of Measure
8	8					Exempt	8	
Clip	2.98	mg	Supplier	Zinc (Zn)	7440-66-6		0.0036	mg
			Supplier	Iron (Fe)	7439-89-6		0.07	mg
			Supplier	Copper (Cu)	7440-50-8		2.9055	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0009	mg
Die	0.47	mg	Supplier	Silicon (Si)	7440-21-3		0.47	mg
Die Attach Solder	0.79	mg	Supplier	Silver (Ag)	7440-22-4		0.0198	mg
			А	Lead (Pb)	7439-92-1	7a	0.7308	mg
			Supplier	Tin (Sn)	7440-31-5		0.0395	mg
Lead Frame	12.27	mg	Supplier	Iron (Fe)	7439-89-6		0.0123	mg
			Supplier	Copper (Cu)	7440-50-8		12.254	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0037	mg
Lead Frame plating	0.14	mg	Supplier	Silver (Ag)	7440-22-4		0.14	mg
Mold Compound-Black	15.0	mg		Epoxy resin	proprietary data		1.125	mg
			Supplier	Phenolic Resin	Proprietary Data		0.375	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		1.125	mg
			Supplier	Carbon Black (C)	1333-86-4		0.075	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		12.3	mg
Plating	0.6	mg	Supplier	Tin (Sn)	7440-31-5		0.6	mg